SUPSiC®

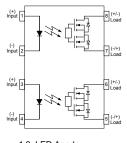
Parameter	Symbol	Rating	Units	
Load Voltage	VL	600	V	
Load Current	lL .	0.08	Α	
On-Resistance	Ron	30	Ω	
I/O Breakdown Voltage	V/ıo	5000	Vrms	



SMD-8



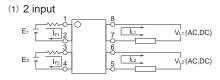
DIP-8

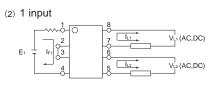


1,3. LED Anode

2,4. LED Cathode 5,6. Drain (MOS FET) 7,8. Drain (MOS FET)







SUPSiC PhotoRelays

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- Small package size

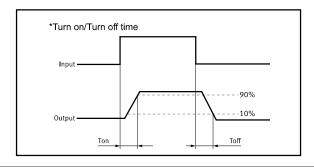
Applications

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- **Energy Management**
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Catagoni		out Rating	Doolsono	Part No.	Packing Overtity	
Category Load Voltage Load Current	Package	Part No.	Packing Quantity			
AC/DC 600V 80mA	00 1	DIP-8	GAQW216E	50pcs /tube		
	80MA	SMD-8	GAQW216EH	1000pcs /reel		





Absolute Maximum Ratings (Ta = 25°C)

	Item	Symbol	Va l ue	Units	Note
Input	Continuous LED Current	I F	50	mA	
	Peak LED Current	I FP	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	Pın	75	mW	
	Load Voltage	V∟	600	V(AC peak or DC)	
	Load Current	l.	0.08	Α	
Output	Peak Load Current	Peak	120	m A	100ms(1 pulse)
	Output Power Dissipation	Pout	450	mW	
Total Power	Dissipation	P⊤	500	mW	
I/O Breakdov	vn Vo l tage	V _{I/O}	5000	Vrms	RH=60%, 1min
Operating Te	emperature	Торг	-40 to 85	°C	
Storage Tem	perature	T _{stg}	-40 to 100	°C	
Pin Soldering	g Temperature	Tsol	260	°C	10 sec max.

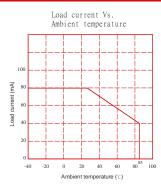
Electrical Characteristics (Ta = 25°C)

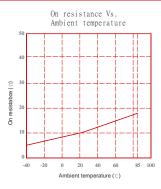
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
	LED Forward Voltage	VF		1.2	1.5	V	I⊧=10mA
	Operation LED Current	Fon		0.5	5.0	mA	
Input	Recovery LED Current	Foff		0.35	0.5	mA	
	Recovery LED Voltage	V _{Foff}	0.7			V	
							I⊧=5mA,I∟=Max
	On-Resistance	Ron		30	42	Ω	Time to flow is within 1 sec.
Output	Off-State Leakage Current	Leak		0.1		uA	V _∟ =Rating
	Output Capacitance	Cout		100		pF	V∟=0, f=1MHz
Transmis	Turn-On Time	Ton		0.2	1.0	ms	I⊧=5mA, I∟=Max
sion	Turn-Off Time	Toff		0.02	0.2	ms	
Coupled	I/O Isolation Resistance	R _{I/O}	10 ¹⁰			Ω	DC500V
Coupled	I/O Capacitance	Ci/o		0.8	1.5	pF	f=1MHz

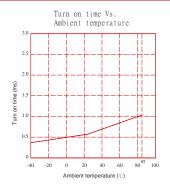
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF \geq 5mA and \leq 30mA

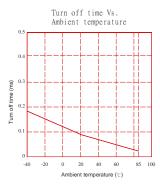


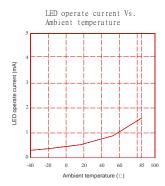
Engineering Data

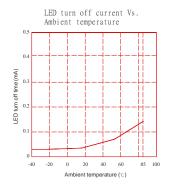


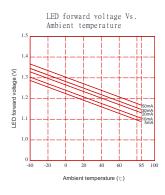


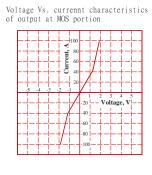


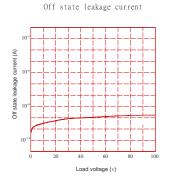


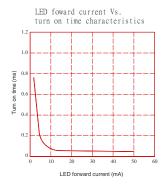


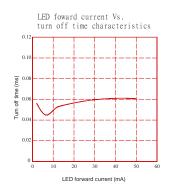


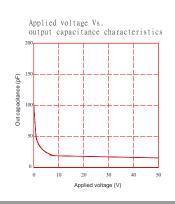










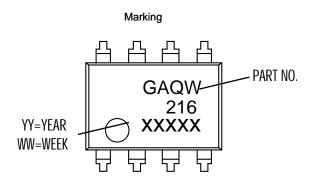


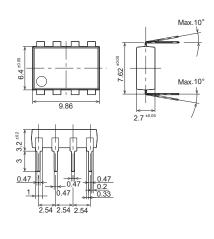


Dimensions and DIP-8 Package

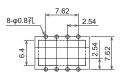
Unit: mm

Through hole terminal type





PC board pattern (Bottom view)



DIP Tape dimensions Unit: mm

Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.



Surface mount terminal type



Dimensions and SMD-8 Package Unit: mm

Recommended mounting pad (Top view)

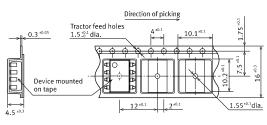


Tape dimensions (tape reel)

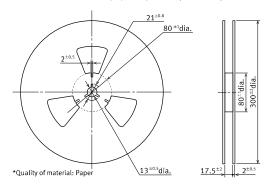
YY=YEAR

WW=WEEK

Tape dimensions (Unit: mm)



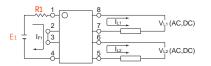
Dimensions of paper tape reel (Unit: mm)





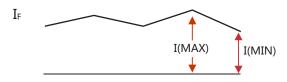
Using Methods

Examples of resistance value to control LED forward current (IF=5mA)



E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9KΩ
24V	4.1K Ω

LED forward current must be more than 5mA, at I(MIN), and less than 30mA, at I(MAX).



Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

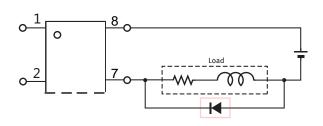
Protection Circuit

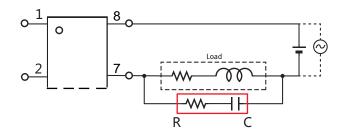
Output spike voltages:if an inductive load generates spike voltages which exceed heabsolute maximum rating, the spike voltage shall be limited.

Clamp diode is connected in parallel with the load.

Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.